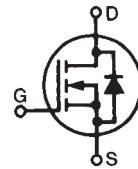


# PolarHT™ Power MOSFET

## IXTK 200N10P

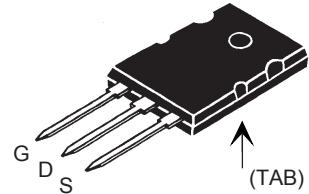
$V_{DSS} = 100 \text{ V}$   
 $I_{D25} = 200 \text{ A}$   
 $R_{DS(on)} \leq 7.5 \text{ m}\Omega$

N-Channel Enhancement Mode  
Avalanche Rated



Symbol	Test Conditions	Maximum Ratings		
$V_{DSS}$	$T_J = 25^\circ\text{C}$ to $175^\circ\text{C}$	100		V
$V_{DGR}$	$T_J = 25^\circ\text{C}$ to $175^\circ\text{C}$ ; $R_{GS} = 1 \text{ M}\Omega$	100		V
$V_{GS}$	Continuous	$\pm 20$		V
$V_{GSM}$	Transient	$\pm 30$		V
$I_{D25}$	$T_c = 25^\circ\text{C}$	200		A
$I_{D(\text{RMS})}$	External lead current limit	75		A
$I_{DM}$	$T_c = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$	400		A
$I_{AR}$	$T_c = 25^\circ\text{C}$	60		A
$E_{AR}$	$T_c = 25^\circ\text{C}$	100		mJ
$E_{AS}$	$T_c = 25^\circ\text{C}$	4		J
$dv/dt$	$I_s \leq I_{DM}$ , $di/dt \leq 100 \text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$ , $T_J \leq 150^\circ\text{C}$ , $R_G = 4 \Omega$	10		V/ns
$P_D$	$T_c = 25^\circ\text{C}$	800		W
$T_J$		-55 ... +175		$^\circ\text{C}$
$T_{JM}$		175		$^\circ\text{C}$
$T_{stg}$		-55 ... +150		$^\circ\text{C}$
$T_L$	1.6 mm (0.062 in.) from case for 10 s	300		$^\circ\text{C}$
$T_{SOLD}$	Plastic body for 10 s	260		$^\circ\text{C}$
$M_d$	Mounting torque	1.13/10	Nm/lb.in.	
Weight		10		g

TO-264 (IXTK)



G = Gate      D = Drain  
S = Source      TAB = Drain

### Features

- ^ International standard package
- ^ Unclamped Inductive Switching (UIS) rated
- ^ Low package inductance
  - easy to drive and to protect

### Advantages

- ^ Easy to mount
- ^ Space savings
- ^ High power density

Symbol	Test Conditions ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)	Characteristic Values		
		Min.	Typ.	Max.
$BV_{DSS}$	$V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	100		V
$V_{GS(\text{th})}$	$V_{DS} = V_{GS}$ , $I_D = 500 \mu\text{A}$	2.5		V
$I_{GSS}$	$V_{GS} = \pm 20 \text{ V}_{DC}$ , $V_{DS} = 0$		$\pm 200$	nA
$I_{DSS}$	$V_{DS} = V_{DSS}$ $V_{GS} = 0 \text{ V}$	$T_J = 150^\circ\text{C}$	25	$\mu\text{A}$
			250	$\mu\text{A}$
$R_{DS(on)}$	$V_{GS} = 10 \text{ V}$ , $I_D = 0.5 I_{D25}$ $V_{GS} = 15 \text{ V}$ , $I_D = 400 \text{ A}$ Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2 \%$	5.5	7.5	$\text{m}\Omega$

Symbol	Test Conditions	Characteristic Values			
		( $T_J = 25^\circ C$ , unless otherwise specified)	Min.	Typ.	Max.
$g_{fs}$	$V_{DS} = 10 V; I_D = 0.5 I_{D25}$ , pulse test	60	97	S	
$C_{iss}$ $C_{oss}$ $C_{rss}$	$V_{GS} = 0 V, V_{DS} = 25 V, f = 1 MHz$	7600	pF		
		2900	pF		
		860	pF		
$t_{d(on)}$ $t_r$ $t_{d(off)}$ $t_f$	$V_{GS} = 10 V, V_{DS} = 0.5 V_{DSS}, I_D = 60 A$ $R_G = 3.3 \Omega$ (External)	30	ns		
		35	ns		
		150	ns		
		90	ns		
$Q_{g(on)}$ $Q_{gs}$ $Q_{gd}$	$V_{GS} = 10 V, V_{DS} = 0.5 V_{DSS}, I_D = 0.5 I_{D25}$	240	nC		
		50	nC		
		135	nC		
$R_{thJC}$			0.18	$^\circ C/W$	
$R_{thcs}$		0.15		$^\circ C/W$	

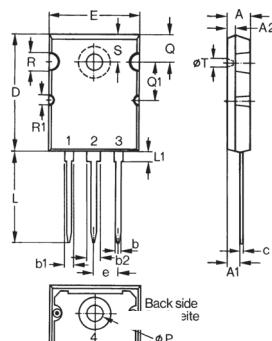
## Source-Drain Diode

## Characteristic Values

 $(T_J = 25^\circ C$ , unless otherwise specified)

Symbol	Test Conditions	Min.	Typ.	Max.
$I_s$	$V_{GS} = 0 V$		200	A
$I_{SM}$	Repetitive		400	A
$V_{SD}$	$I_F = I_s, V_{GS} = 0 V$ , Pulse test, $t \leq 300 \mu s$ , duty cycle $d \leq 2\%$		1.5	V
$t_{rr}$ $Q_{RM}$	$I_F = 25 A, -di/dt = 100 A/\mu s$ $V_R = 50 V, V_{GS} = 0 V$	100	ns	
		3.0	$\mu C$	

## TO-264 (IXTK) Outline

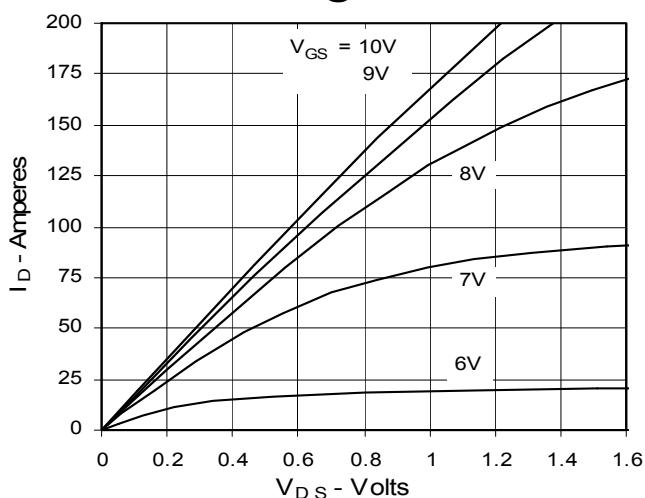


Dim.	Millimeter Min.	Millimeter Max.	Inches Min.	Inches Max.
A	4.82	5.13	.190	.202
A1	2.54	2.89	.100	.114
A2	2.00	2.10	.079	.083
b	1.12	1.42	.044	.056
b1	2.39	2.69	.094	.106
b2	2.90	3.09	.114	.122
c	0.53	0.83	.021	.033
D	25.91	26.16	1.020	1.030
E	19.81	19.96	.780	.786
e	5.46	BSC	.215	BSC
J	0.00	0.25	.000	.010
K	0.00	0.25	.000	.010
L	20.32	20.83	.800	.820
L1	2.29	2.59	.090	.102
P	3.17	3.66	.125	.144
Q	6.07	6.27	.239	.247
Q1	8.38	8.69	.330	.342
R	3.81	4.32	.150	.170
R1	1.78	2.29	.070	.090
S	6.04	6.30	.238	.248
T	1.57	1.83	.062	.072

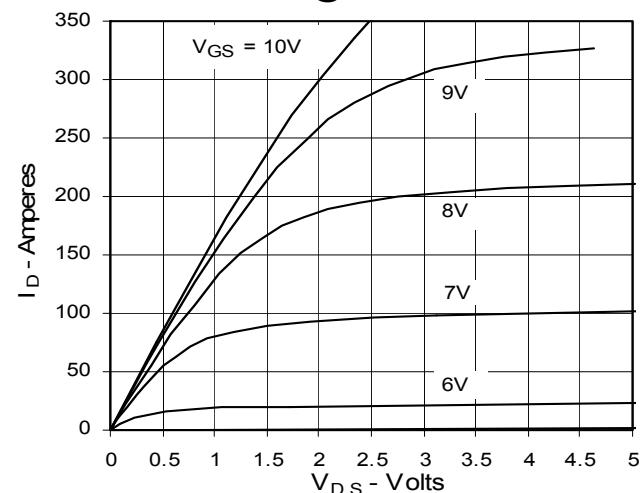
IXYS reserves the right to change limits, test conditions, and dimensions.

IXYS MOSFETs and IGBTs are covered by 4,835,592 4,931,844 5,049,961 5,237,481 6,162,665 6,404,065 B1 6,683,344 6,727,585 one or more of the following U.S. patents: 4,850,072 5,017,508 5,063,307 5,381,025 6,259,123 B1 6,534,343 6,710,405B2 6,759,692 4,881,106 5,034,796 5,187,117 5,486,715 6,306,728 B1 6,583,505 6,710,463 6,771,478 B2

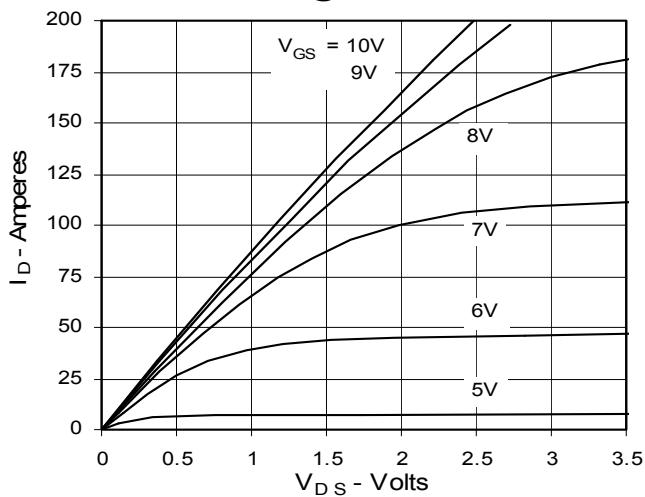
**Fig. 1. Output Characteristics  
@ 25°C**



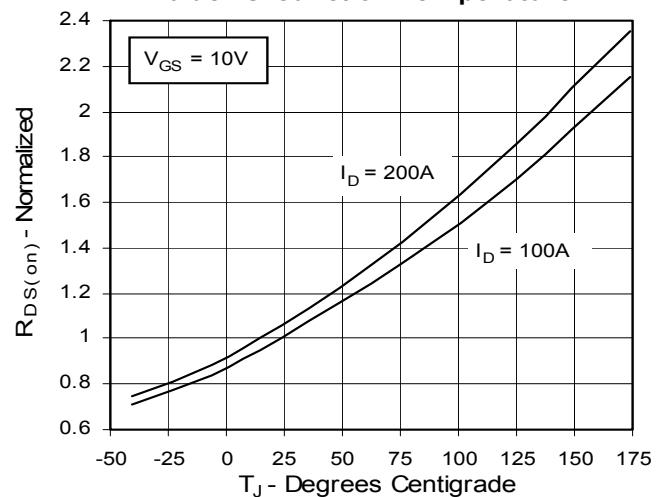
**Fig. 2. Extended Output Characteristics  
@ 25°C**



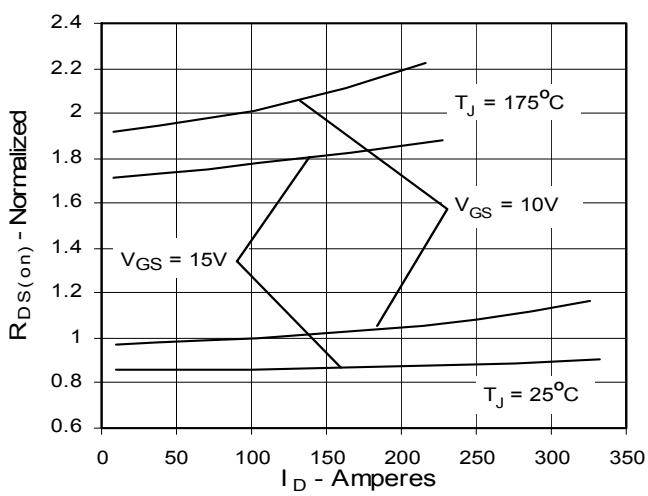
**Fig. 3. Output Characteristics  
@ 150°C**



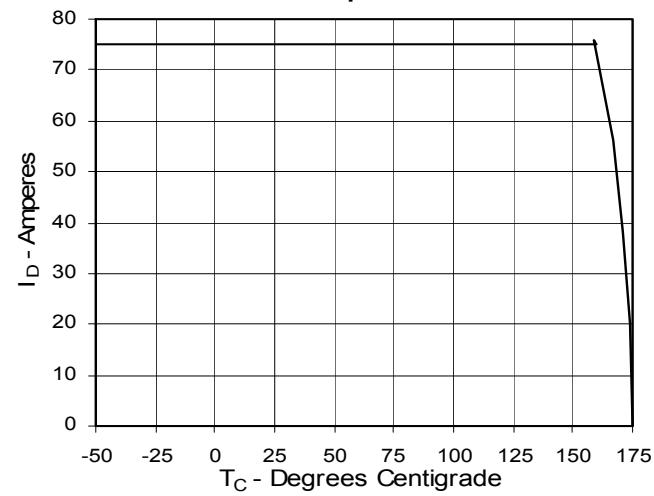
**Fig. 4.  $R_{DS(on)}$  Normalized to 0.5  $I_{D25}$  Value vs. Junction Temperature**

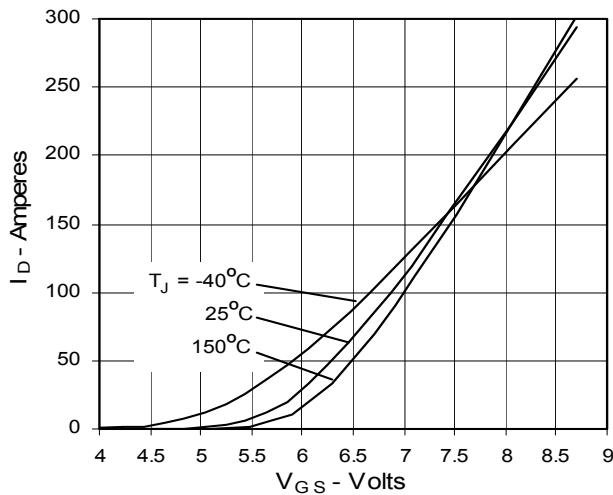
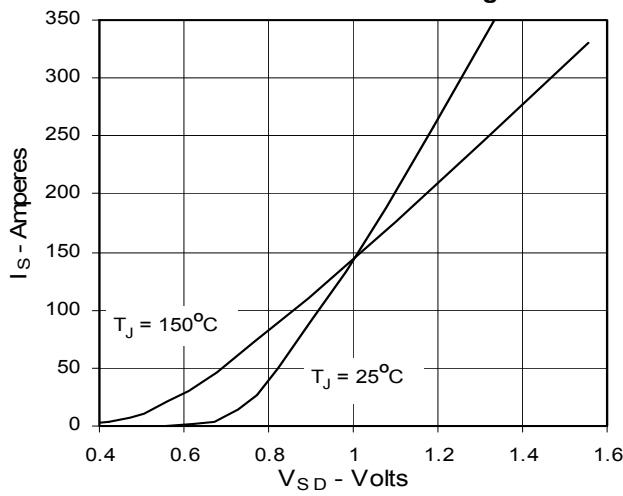
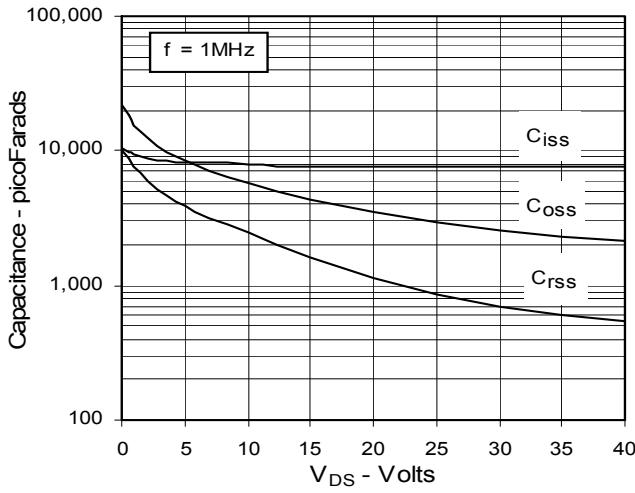
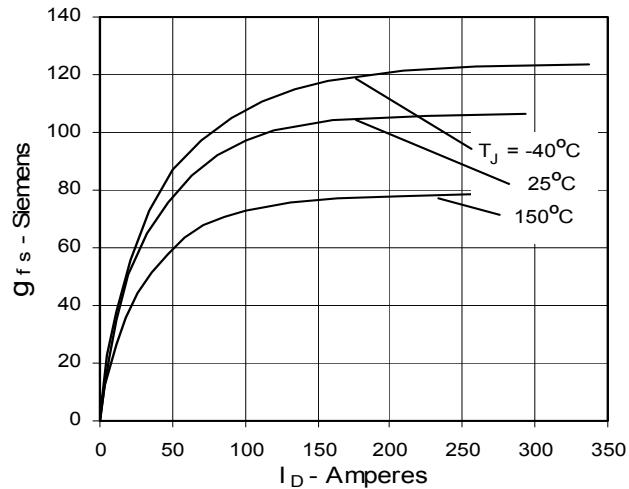
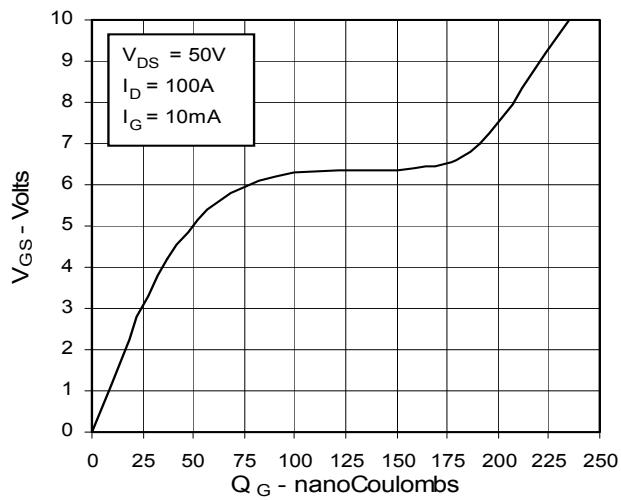
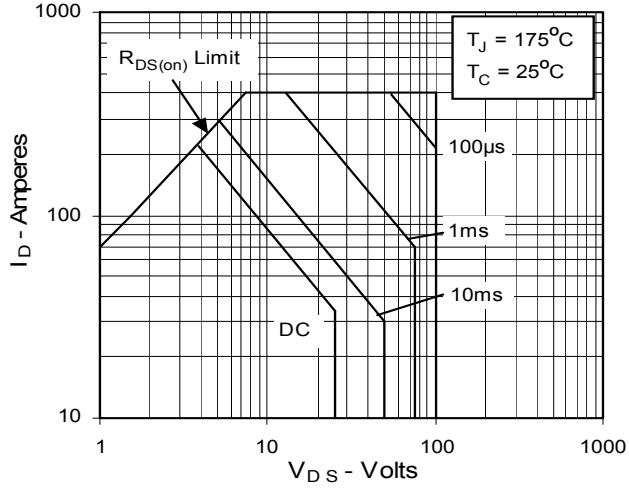


**Fig. 5.  $R_{DS(on)}$  Normalized to 0.5  $I_{D25}$  Value vs. Drain Current**



**Fig. 6. Drain Current vs. Case Temperature**



**Fig. 7. Input Admittance****Fig. 9. Source Current vs. Source-To-Drain Voltage****Fig. 11. Capacitance****Fig. 8. Transconductance****Fig. 10. Gate Charge****Fig. 12. Forward-Bias Safe Operating Area**

**Fig. 13. Maximum Transient Thermal Resistance**